

October 2015

Chip Protectors

For ESD protection

SGNE series

SGNE04 SGNE06 0402 [01005 inch]* 0603 [0201 inch]

* Dimensions Code JIS[EIA]

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

O Please note the following precautions in order to avoid problems with chip protectors such as characteristic degradation and element destruction.

Please store these products in an environment with a temperature of 5 to 40°C and humidity level of 20 to 70%RH, and use them within six months.

Poor storage conditions may lead to the deterioration of the solderability of the terminal electrodes, so please be careful to avoid contact with humidity, dew condensation, dust, toxic gas (hydrogen, hydrogen sulfide, sulfurous acid, chlorine, ammonia, etc.), direct sunlight, and so on.

Please do not use products that have been dropped or detached when mounting.

Please solder with the reflow soldering method, and not the flow (dip) soldering method.

O Please note the following precautions to avoid problems with chip protectors such as characteristic degradation and element destruction, which ultimately lead to the generation of heat and smoke with the elements.

Do not use in locations where the temperatures exceed the operating temperature range such as under direct sunlight or near sources of heat.

Do not use in locations where there are high levels of humidity such as under direct exposure to weather and areas where steam is released.

Do not use in locations such as dusty areas, high-saline environments, places where the atmosphere is contaminated with corrosive gas, etc.

Avoid powerful vibrations, impact (such as by dropping), pressure, etc. that may lead to splitting in the products.

Do not use with a voltage that exceeds the maximum allowable circuit voltage.

When resin coating (including modular) a varistor, do not use a resin that will cause deterioration of the varistor. Be sure never to use resin that generates hydrogen as palladium is used for the inner electrode.

Avoid attachment near combustible materials.

Please contact our sales offices when considering the use of the products listed on this catalog for applications, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property ('specific uses' such as automobiles, airplanes, medical instruments, nuclear devices, etc.) as well as when considering the use for applications that exceed the range and conditions of this catalog. Please also contact us when using these products for automotive applications.

Please note that we are not responsible for any damages or losses incurred resulting from the use of these products that exceeds the range and conditions of this catalog or specific uses.

Please take appropriate measures such as acquiring protective circuits and devices that meet the uses, applications, and conditions of the instruments and keeping backup circuits.

⊗TDK

Chip Protectors ESD Protection

Product compatible with RoHS directive Compatible with lead-free solders

Overview of the SGNE Series

FEATURES

- O Multilayer chip protector is the ESD protection solution which is using a semiconductor ceramic.
- \bigcirc It is the possible replacement of TVS Diode for ESD protectrion.
- Chip size is available with EIA01005(0402mm), EIA0201(0603mm).
- O Rather than the present products of TDK, it has the outstanding ESD absorption feature.
- Excellent ESD protection characteristic. (Based on IEC61000-4-2, Contact-8kV)

APPLICATION

- ESD protection such as signal line, audio line
- ◯ Filter for EMI protection
- Smart phone, tablet PC, portable music player, note PC, etc

PART NUMBER CONSTRUCTION

SGNE	04	С	080	М	T	150	Ν	25
	L×W		Breakdown	Varistor voltage			Capacitance	ESD Clamp voltage
Series name	Dimensions (mm)	Structure	voltage (V)	tolerance (%)	Packaging style	Capacitance (pF)	tolerance* (%)	Average voltage (IEC61000-4-2, 8kV)
	04 0.4×0.2		080 8	M ±20	T Taping	150 15	N ±30	<u> </u>

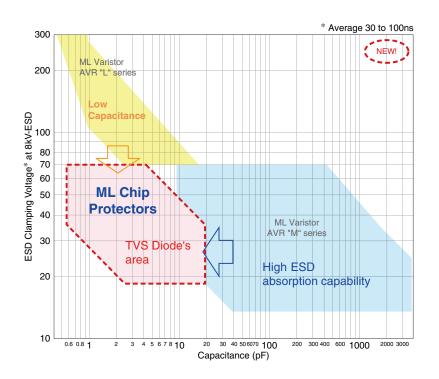
O RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/

Voltage Protection Devices

Overview of the SGNE Series

TDK ESD Protection Device Map

Multilayer chip protector is a ESD protection component which has excellent ESD absorption characteristic and the low capacitance. This SGNE series is suitable for the applications which require the low clamping voltage and the low capacitance.

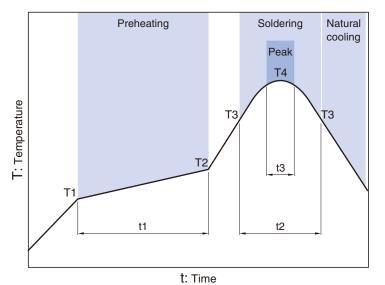


⊗TDK

(4/10)

Overview of the SGNE Series

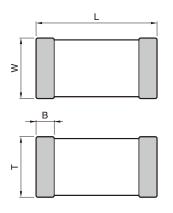
RECOMMENDED REFLOW PROFILE



Preheating Soldering Peak Temp. Time Temp. Time Temp. Time T1 T2 Т3 t2 Т4 t3 t1 150°C 180°C 120s max. 230°C 40s max. 260°C max. 5s

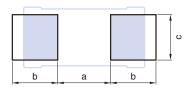
SGNE04/SGNE06 Types

SHAPE & DIMENSIONS



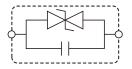
				Dimensions in mm
EIA	L	W	Т	В
01005	0.4±0.02	0.2±0.02	0.2±0.02	0.07min.
0201	0.6±0.03	0.3±0.03	0.3±0.03	0.1min.

RECOMMENDED LAND PATTERN



		Dir	Dimensions in mm			
EIA	а	b	С			
01005	0.20	0.15 to 0.20	0.18 to 0.20			
0201	0.25 to 0.35	0.20 to 0.30	0.25 to 0.35			

CIRCUITS DIAGRAM



⊗TDK

SGNE series SGNE04/SGNE06 Types

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

	Maximum continuous voltage	Breakdown voltage V(V)	Capacitance	Leakage current	ESD Clamp voltage Average Voltage
Part No.	Vdc(V)	[1mA]	C(pF) [1MHz]	Vdc(µA)	(V) [IEC61000-4-2, 8kV]
	max.			max.	max.
EIA01005(0402mm)					
SGNE04C080MT150N25	4.3	8 (6.4 to 9.6)	15 (10.5 to 19.5)	20	25
EIA0201(0603mm)					
SGNE06C080MT150N25	4.3	8 (6.4 to 9.6)	15 (10.5 to 19.5)	20	25
SGNE06C270MT6R8G60	15	27 (21.6 to 32.4)	6.8 (4.8 to 8.8)	20	60

· Short bar residual inductance =0nH

• All specifications are subject to change without notice.

⊗TDK

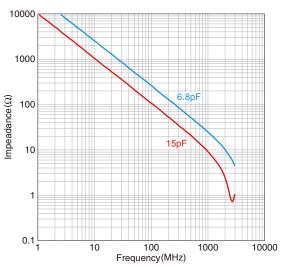
Voltage Protection Devices

SGNE series SGNE04/SGNE06 Types

ELECTRICAL CHARACTERISTICS

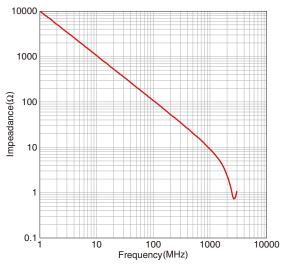
IMPEDANCE vs. FREQUENCY CHARACTERISTICS

SGNE 0603mm Case Size



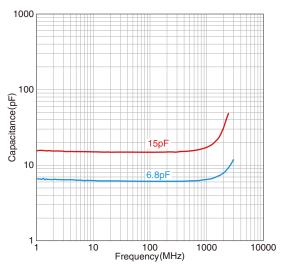
· Short bar residual inductance =0nH

SGNE 15pF Type **IMPEDANCE vs. FREQUENCY CHARACTERISTICS**

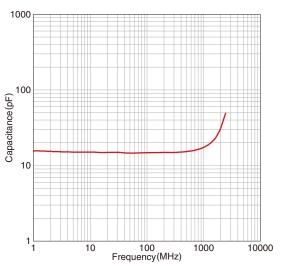


· Short bar residual inductance =0nH

CAPACITANCE vs. FREQUENCY CHARACTERISTICS



CAPACITANCE vs. FREQUENCY CHARACTERISTICS



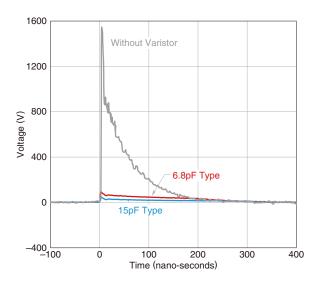
• All specifications are subject to change without notice.

公TDK

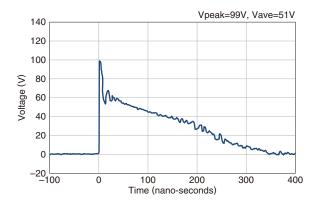
Voltage Protection Devices

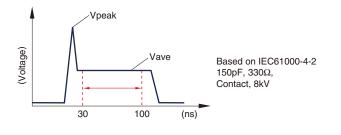
SGNE series SGNE04/SGNE06 Types

ESD CLAMP CHARACTERISTICS



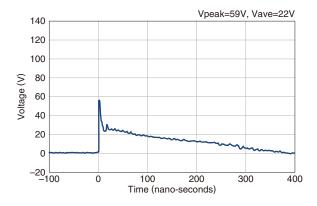
SGNE06C270MT6R8G60



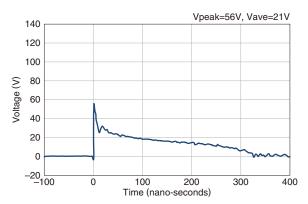


ESD Clamping Voltage(V, at 8kV)		
Vpeak	Vave	
1561	395	
59	22	
99	51	
56	21	
	Voltage(V, a Vpeak 1561 59 99	Voltage(V, at 8kV) Vpeak Vave 1561 395 59 22 99 51

SGNE06C080MT150N25



SGNE04C080MT150N25



(9/10)

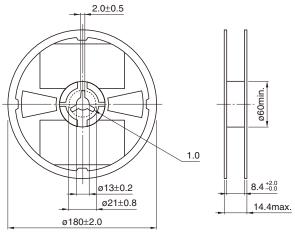
⊗TDK

Voltage Protection Devices

SGNE series

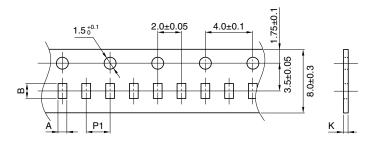
Packaging Style

REEL DIMENSIONS

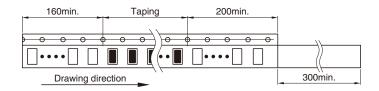


Dimensions in mm

TAPE DIMENSIONS



Dimensions in m						
Туре	A	В	P1	K		
SGNE0402	0.26±0.04	0.46±0.04	2.0±0.05	0.4max.		
SGNE0603	0.38±0.05	0.68±0.05	2.0±0.05	0.45max.		



Dimensions in mm

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TDK:

SGNE06C080MT150N25 SGNE06C270MT6R8G60